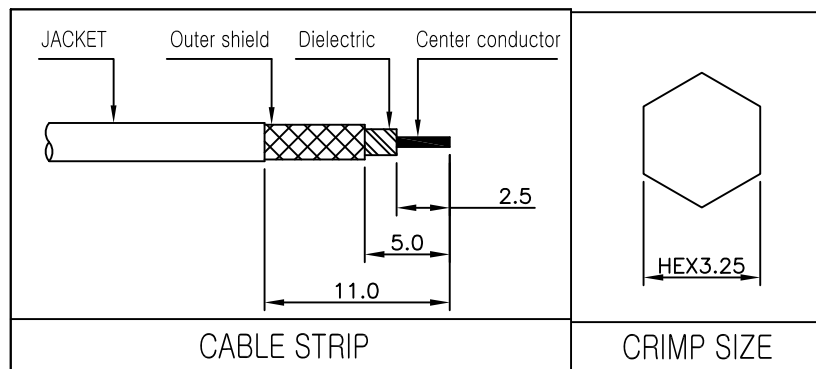
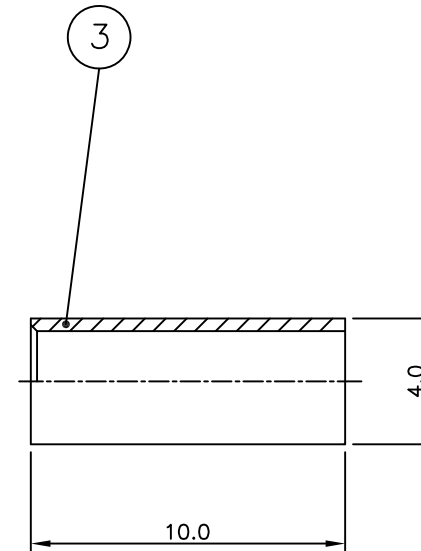
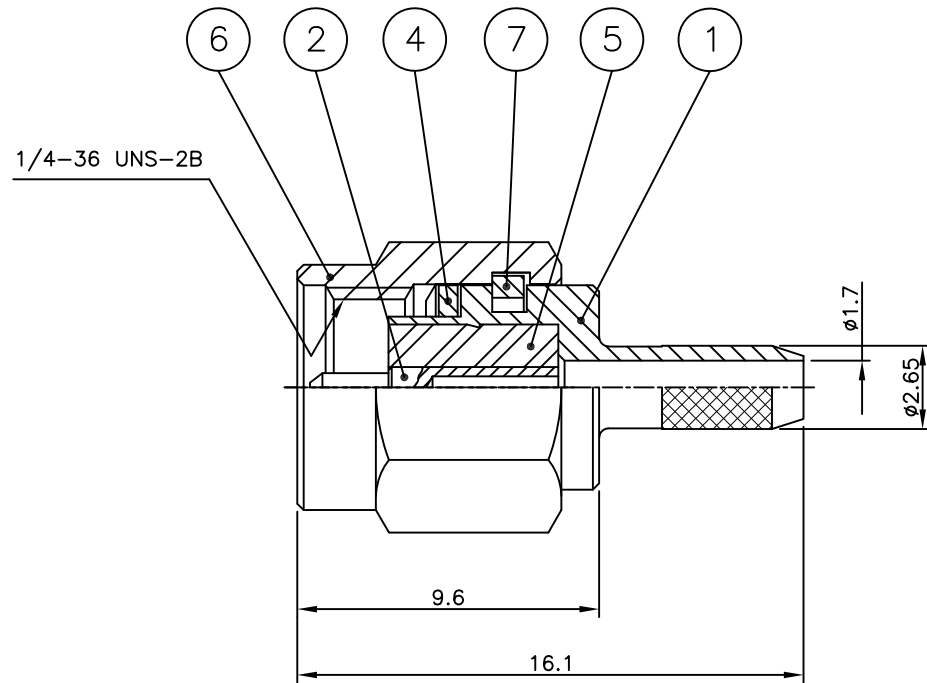


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2015.11.03.
1	고객사 커넥터 압착부 바디 부러짐 현상 개선으로 인한 R추가	S.Y.EUN	I.C.KIM	2020.12.08.
2	[설번No.202203-0008] PIPE 공용화 부품 적용으로 인한 코드 변경	S.Y.EUN	S.H.KIM	2022.03.15.



7	SPRING RING	1	Pasivated	부동태처리	DSR00002-5/1 (R2001)
6	COUPLING CAP	1	MBsBD	Gold Plate	DCU00005-5/1 (K2001)
5	INSULATOR	1	TEFLON	White	DIN01667-N/1
4	GASKET	1			DGK00004-N/1 (G2001)
3	FERRULE	1	MBsBD	Nickel Plate Gold Plate	DFE00034-5/1 DFE00031-5/1 (F2002)
2	CONTACT	1	MBsBD	Gold Plate	DCT00292-5/1 (E2001)
1	BODY	1	MBsBD	Gold Plate	DBD00128-5/4 DBD00128-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2022. 03. 15.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY	S.H.KIM		
MATERIAL —		CHECKED BY	TITLE SMA50 CABLE PS RG316		
		DRAWN BY			
FINISH —	SCALE 4/1	UNIT mm		A4	DWG NO. CN00962-7/4
					REVISION 1